# SiS126DN

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**Vishay Siliconix** 



# N-Channel 80 V (D-S) MOSFET



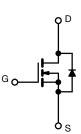
PRODUCT SUMMARY	
V <sub>DS</sub> (V)	80
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0102
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 7.5 V	0.0125
Q <sub>g</sub> typ. (nC)	16
I <sub>D</sub> (A)	45.1 <sup>a, g</sup>
Configuration	Single

### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> x Q<sub>oss</sub> FOM
- 100 % R<sub>q</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- Motor drive switch
- · Battery and load switch
- Industrial



ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiS126DN-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, u	Inless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	80	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		45.1		
	T <sub>C</sub> = 70 °C	1 .	36.1	t I	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	12 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	9.7 <sup>b, c</sup>	Τ.	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	100	A	
	T <sub>C</sub> = 25 °C		47.2	Ì	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.3 <sup>b, c</sup>		
Single pulse avalanche current L = 0.1 mH		I <sub>AS</sub>	20		
Single pulse avalanche energy		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		52		
Manufacture and a strength of the strength of	T <sub>C</sub> = 70 °C		33.3	w	
Maximum power dissipation	T <sub>A</sub> = 25 °C	PD	3.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	2.4 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	•••	
Soldering recommendations (peak temperature) <sup>c</sup>		İ	260	°C	

THERMAL RESISTANCE RATING	as and a second s				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	24	33	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.9	2.4	0/10

Notes Package limited a.

b. Surface mounted on 1" x 1" FR4 board

t = 10 s See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 81 °C/W  $T_{C} = 25$  °C d.

e.

f.

g.

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FREE

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SiS126DN

## Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	80	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	l <sub>D</sub> = 10 mA	-	63	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-6.6	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	-	3.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
Zaus and a solita an alusia assument		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	IDSS	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ 10 V, $V_{GS}$ = 10 V	40	-	-	Α
	<b>D</b>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0085	0.0102	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0097	0.0125	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	39	-	S
Dynamic <sup>b</sup>			•		•	
Input capacitance	C <sub>iss</sub>		-	1402	-	
Output capacitance	$ \begin{array}{c} \hline C_{iss} \\ \hline C_{oss} \\ \hline C_{oss} \\ \hline \\ ance \\ \hline C_{rss} \\ \hline \\ Q_g \\ \hline \\ \hline \\ Q_{gs} \\ \hline \\ Q_{gg} \\ \hline \\ \hline \\ Q_{gg} \\ \hline \\ Q_{gg} \\ \hline \\ Q_{gg} \\ \hline \\ Q_{gg} \\ \hline \\ Q_{Ss} \\ \hline \\ V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ A} \\ \hline \\ Q_{gg} \\ \hline \\ Q_{OS} \\ \hline \\ Q_{DS} = 40 \text{ V}, \text{ V}_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A} \\ \hline \\ Q_{gg} \\ \hline \\ Q_{oss} \\ \hline \\ V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V} \\ \end{array} $	-	176	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	11.2	-	
		$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	21.1	32	
Total gate charge	Qg		-	16	24	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 40 V, $V_{GS}$ = 7.5 V, $I_{D}$ =10 A	-	6.5	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	3.4	-	1
Output charge	Q <sub>oss</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	23.5	-	
Gate resistance	Rg	f = 1 MHz	0.2	0.76	1.4	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	13	26	
Rise time	t <sub>r</sub>	$V_{DD} = 40 \text{ V}, \text{ R}_{L} = 4 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	6	12	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	16	32	
Fall time	t <sub>f</sub>		-	6	12	
Turn-on delay time	t <sub>d(on)</sub>		-	14	28	ns
Rise time	tr	$V_{DD} = 40 \text{ V}, \text{ R}_{L} = 4 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	6	12	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	15	30	1
Fall time	t <sub>f</sub>		-	6	12	
Drain-Source Body Diode Characteris	tics					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	47.2	٨
Pulse diode forward current	I <sub>SM</sub>		-	-	10	A
Body diode voltage	V <sub>SD</sub>	$I_{S} = 5 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	0.78	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	36	72	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs,	-	43	86	nC
Reverse recovery fall time	ta	$T_J = 25 \ ^\circ C$	-	24	-	
Reverse recovery rise time	t <sub>b</sub>		-	12	-	ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

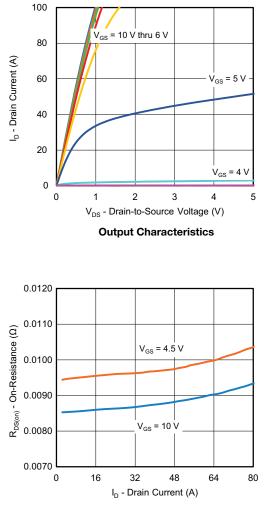
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

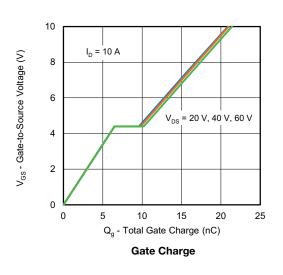
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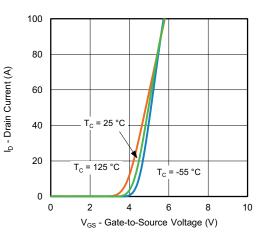


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

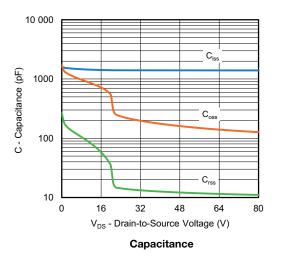


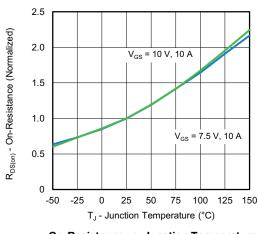
**On-Resistance vs. Drain Current and Gate Voltage** 





**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

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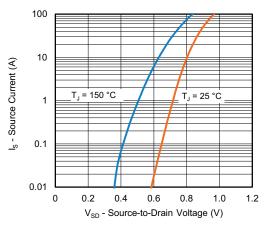
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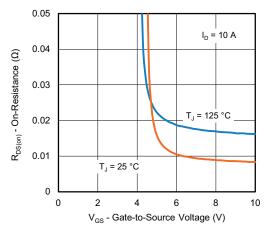
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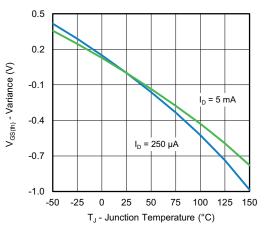
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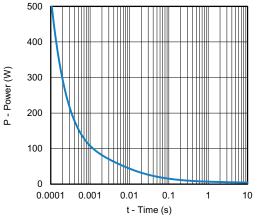
Source-Drain Diode Forward Voltage



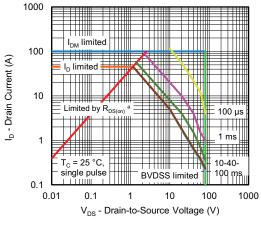
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Case

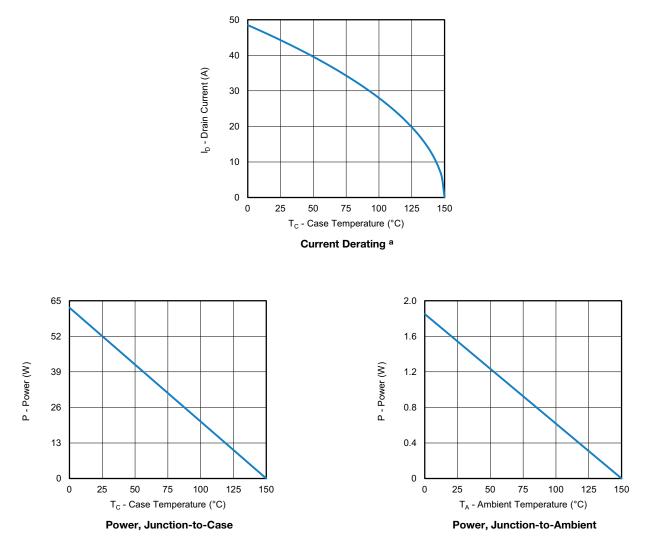
#### Note

a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

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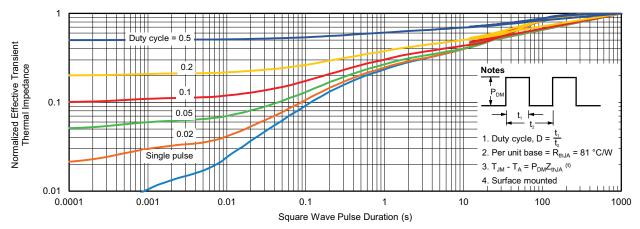


#### Note

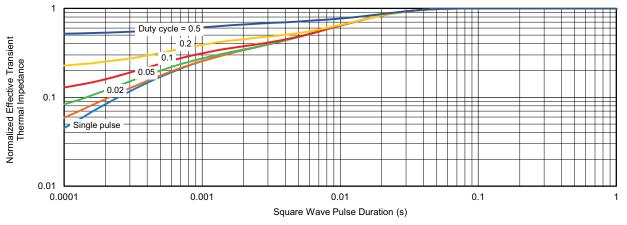
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

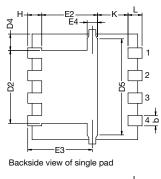
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# PowerPAK® 1212-8, (Single / Dual)









Notes

1. Inch will govern

Dimensions exclusive of mold gate burrs
Dimensions exclusive of mold flash and cutting burrs

DIM.	MILLIMETERS			INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D3	0.48	-	0.89	0.019	-	0.035	
D4		0.47 typ. 0.0185					
D5		2.3 typ.		0.090 typ			
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4		0.034 typ.			0.013 typ.		
е	0.65 BSC				0.026 BSC		
К		0.86 typ.			0.034 typ.		
K1	0.35	-	-	0.014	-	-	
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			
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Revison: 09-Jan-17

Document Number: 71656

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## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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